						\rightarrow [1]
ш	0	0	n		0	e Th
	d			S		

Document Title	HSD043I9W1 Specification	Page No.	1/22
Document No.	DC170-002854	Revision	1.0

TO :

Date : 2009/04/21

Customer Acceptance Specification

Model : HSD043I9W1 -A01

相關文件:IIS DC170-002598

Accepted by:

Signature

Date

Proposed by: Technical Service Division

Signature

Date

Note:1. Please contact HannStar Display Corp. before designing your product based on this module specification.

2. The information contained herein is presented merely to indicate the characteristics and performance of our products. No responsibility is assumed by HannStar for any intellectual property claims or other problems that may result from application based on the module described herein.



Document Title	HSD043I9W1 Specification	Page No.	2/22
Document No.	DC170-002854	Revision	1.0

	Record of Revisions						
Rev.	Date	Sub-Model	Description of change				
Rev. 1.0	Date 2009/04/21	Sub-Model A01	Description of change Formal Product Specification was first issued.				

HannStar	HannStar Display Corp.					
Document Title	HSD043I9W1 Specification	Page No.	3/22			
Document No.	Document No. DC170-002854 Revision					
	Contents					
1.0	General description		p.4			
2.0	Absolute maximum ratings		p.5			
3.0	Optical characteristics		p.6			
4.0	Block diagram		p.10			
5.0	Interface pin connection		p.11			
6.0	Electrical characteristics		p.12			
7.0	Reliability test items		p.17			
8.0	Outline dimension		p.18			
9.0	Lot mark		p.19			
10.0	Package specification		p.20			
11.0	General precaution		p.21			



Document Title	HSD043I9W1 Specification	Page No.	4/22
Document No.	DC170-002854	Revision	1.0

1.0 GENERAL DESCRIPTION

1.1 Introduction

HannStar Display model HSD043I9W1-A is a color active matrix thin film transistor (TFT) liquid crystal display (LCD) that uses amorphous silicon TFT as a switching device. This model is composed of a TFT LCD panel, a driving circuit and a back light system. This TFT LCD has a 4.3 (16:9) inch diagonally measured active display area with WQVGA (480 horizontal by 272 vertical pixel) resolution.

1.2 Features

- 4.3 (16:9 diagonal) inch configuration
- 8-bit color depth with 256 gray-scale
- Parallel 24-bit RGB data input
- RoHS and Halogen-Free compliance

1.3 Applications

- Personal Navigation Device
- Multimedia applications and Others AV system

1.4 General information

••••••			
Item		Specification	Unit
Outline Dimens	ion	105.5 x 67.2 x 2.9 (Typ.)	mm
Display area		95.04 (H) x 53.856 (V)	mm
Number of Pixe	1	480 RGB (H) x 272 (V)	pixels
Pixel pitch		0.198 (H) x 0.198 (V)	mm
Pixel arrangement		RGB Vertical stripe	
Display mode		Normally white	
Surface treatme	ent	Antiglare, Hard-Coating (3H)	
Weight		43.5 (Тур.)	g
Back-light		LED Side-light type	
Power	Logic System	0.09 (Max.)	W
Consumption	B/L System	0.924 (Max.)	W

1.5 Mechanical Information

	Item	Min.	Тур.	Max.	Unit
Madula	Horizontal (H)	105.2	105.5	105.8	mm
Module Size	Vertical (V)	66.9	67.2	67.5	mm
Size	Depth (D)	_	2.9	3.2	mm
Weight (With	Weight (Without inverter)		43.5	_	g



Document Title	HSD043I9W1 Specification	Page No.	5/22
Document No.	DC170-002854	Revision	1.0

2.0 ABSOLUTE MAXIMUM RATINGS

2.1 Electrical Absolute Rating

2.1.1 TFT LCD Module

Item	Symbol	Min.	Max.	Unit	Note
Power supply voltage	VDD	-0.3	5.0	V	GND=0
Logic Signal Input Level	Vi	-0.3	5.0	V	

2.1.2 Back-Light Unit

Item	Symbol	Тур.	Max.	Unit	Note
LED current	ΙL	40	_	mA	(1)(2)(3)
LED voltage	V_L	19.8		V	(1)(2)(3)

Note

- (1) Permanent damage may occur to the LCD module if beyond this specification. Functional operation should be restricted to the conditions described under normal operating conditions.
- (2) Ta =25±2°C
- (3) Test Condition: LED current 40 mA. The LED lifetime could be decreased if operating IL is larger than 40mA.

2.2 Environment Absolute Rating

Item	Symbol	Min.	Max.	Unit	Note
Operating Temperature	T_{opa}	-20	70	°C	
Storage Temperature	T_{stg}	-30	80	°C	



Document Title	HSD043I9W1 Specification	Page No.	6/22	
Document No.	DC170-002854	Revision	1.0	

3.0 OPTICAL CHARACTERISTICS

3.1 Optical specification

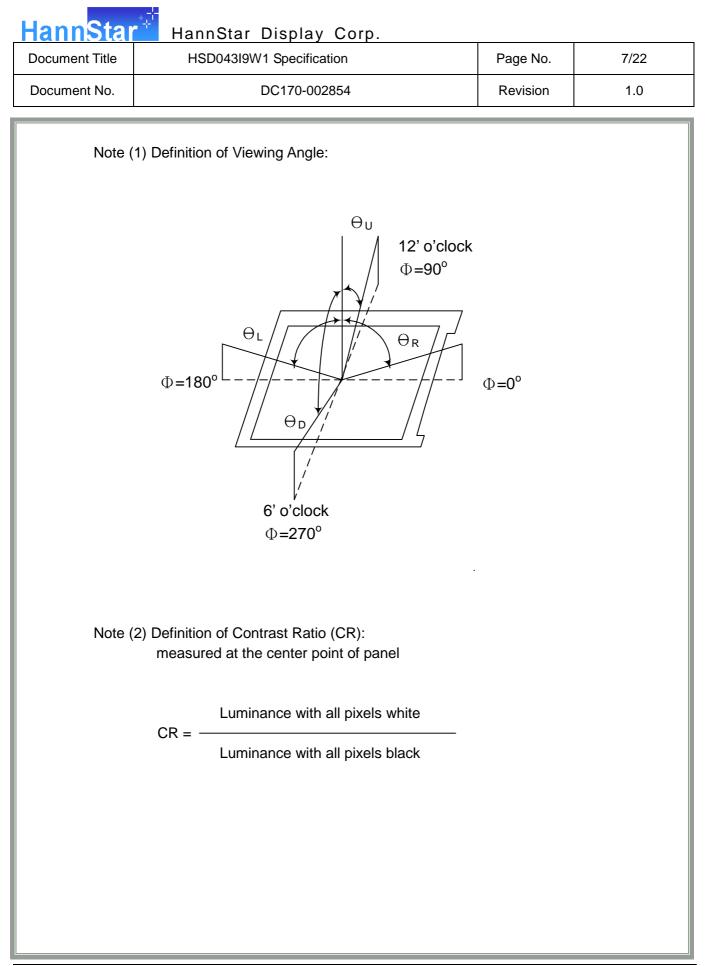
Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Note
Contrast		CR		480	600	—		(1)(2)
Response	Rising	T _R			3	6		((
time	Falling	T _F	⊖ = 0	_	7	14	msec	(1)(3)
White luminance (Center)		YL	Normal viewing	400	500		cd/m ²	(1)(4)(7) (I _L =40mA)
Color			angle	0.260	0.310	0.360		
chromaticity (CIE1931)	White	Wy		0.280	0.330	0.380		
	Llor	Θ_{L}		65	75	_		(1)(1)
Viewing	Hor.	Θ_{R}		65	75	_		(1)(4)
angle		θu	CR>10	50	60	—		
	Ver.	θD		60	70	_		
Brightness uniformity		B _{UNI}	⊖=0	70	_		%	(5)(7)
Optima View Direction		6 O' clock						(6)

3.2 Measuring Condition

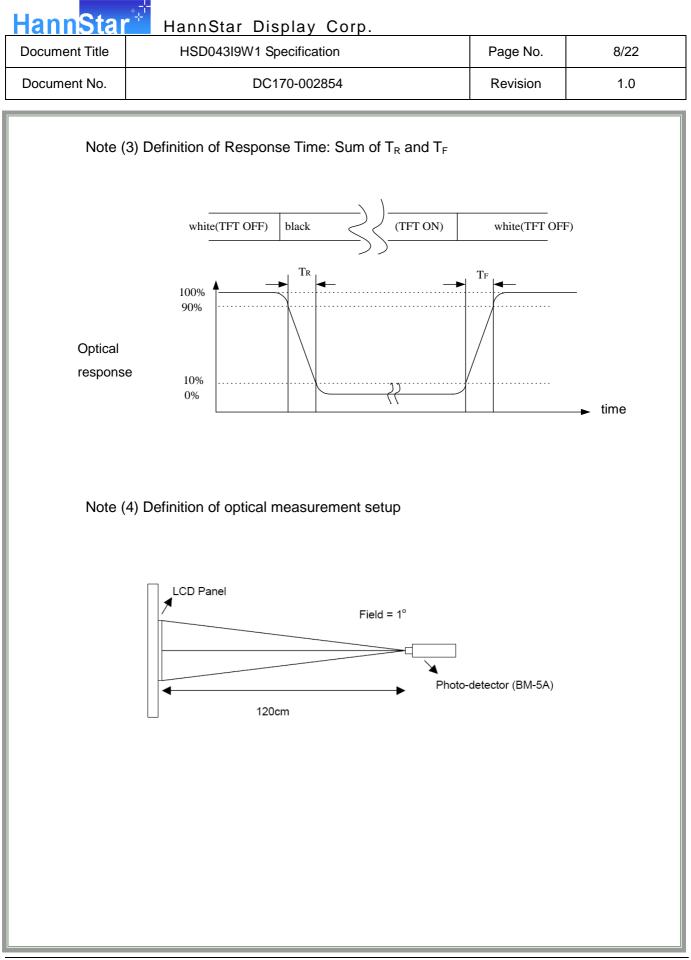
- Measuring surrounding: dark room
- LED current I_L: 40mA
- Ambient temperature: 25±2°C
- 15min. warm-up time.

3.3 Measuring Equipment

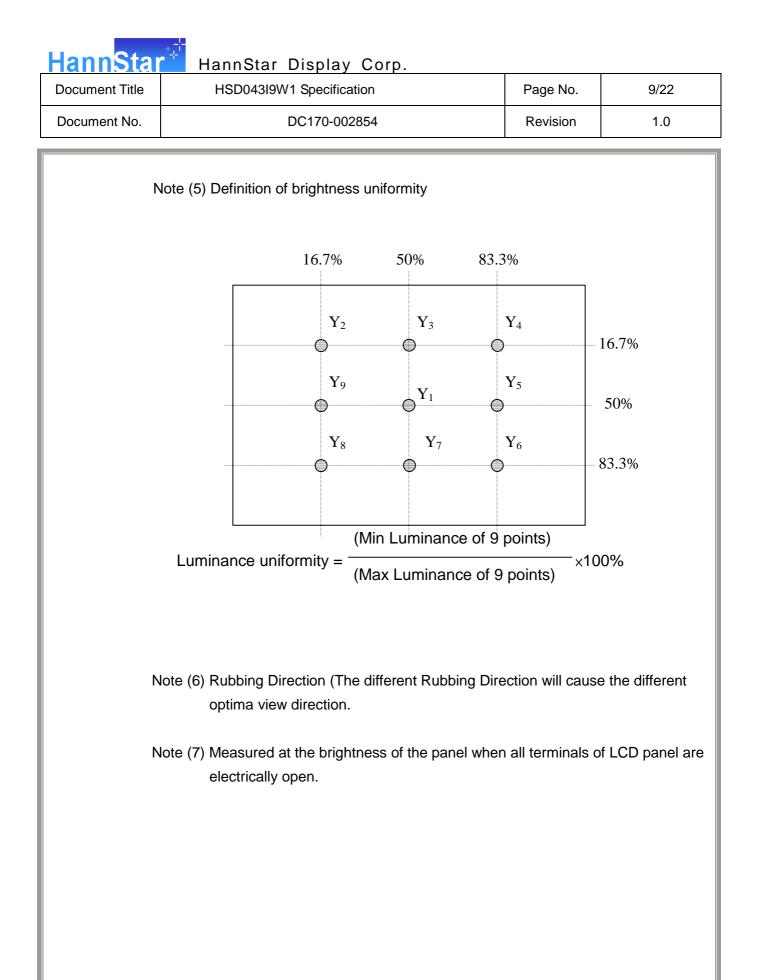
- FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics.
- Measuring spot size: 20 ~ 21 m



The information contained in this document is the exclusive property of HannStar Display Corporation. It shall not be disclosed, distributed or reproduced in whole or in part without written permission of HannStar Display Corporation.



The information contained in this document is the exclusive property of HannStar Display Corporation. It shall not be disclosed, distributed or reproduced in whole or in part without written permission of HannStar Display Corporation.



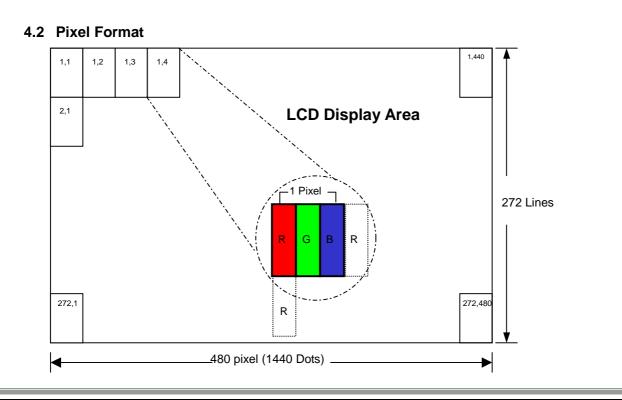
HannStar	HannStar Display Corp.		
Document Title	HSD043I9W1 Specification	Page No.	10/22
Document No.	DC170-002854	Revision	1.0
4.0 BLOCK D 4.1 TFT L	IAGRAM CD Module		

Display Area

T-CON/ Driver IC

FPC

LED back light





Document Title	HSD043I9W1 Specification	Page No.	11/22
Document No.	DC170-002854	Revision	1.0

5.0 INPUT INTERFACE PIN ASSIGNMENT

FPC connector is used for electronics interface. The recommended model is FH19SC-40S-0.5SH (05) manufactured by HIROSE.

Pin No	Symbol	I/O	Function
1	V _{LED-}	Р	Power for LED backlight cathode
2	V _{LED+}	Р	Power for LED backlight anode
3	GND	Р	Power ground
4	V _{DD}	Р	Power voltage
5	R0	I	Red data (LSB)
6	R1	I	Red data
7	R2	I	Red data
8	R3	I	Red data
9	R4	I	Red data
10	R5	I	Red data
11	R6	I	Red data
12	R7	I	Red data (MSB)
13	G0	I	Green data (LSB)
14	G1	I	Green data
15	G2	I	Green data
16	G3	I	Green data
17	G4	I	Green data
18	G5	-	Green data
19	G6		Green data
20	G7		Green data (MSB)
21	B0	Ι	Blue data (LSB)
22	B1	Ι	Blue data
23	B2		Blue data
24	B3	Ι	Blue data
25	B4	Ι	Blue data
26	B5	Ι	Blue data
27	B6	Ι	Blue data
28	B7	Ι	Blue data (MSB)
29	GND	Р	Power ground
30	DCLK	I	Pixel clock
31	DISP	Ι	Display on/ off
32	HSYNC	Ι	Horizontal sync signal
33	VSYNC	Ι	Vertical sync signal
34	DE		Data enable
35	NC	-	No connect
36	GND	Р	Power ground
37	X_R	I/O	Right electrode - differential analog
38	Y_B	I/O	Bottom electrode - differential analog
39	X_L		Left electrode - differential analog
40	Y_T	I/O	Top electrode - differential analog

I/O: I: input, O: output, P: power



Document Title	HSD043I9W1 Specification	Page No.	12/22
Document No.	DC170-002854	Revision	1.0

6.0 ELECTRICAL CHARACTERISTICS

6.1 DC Electrical Characteristics

Parameters	Symbol	Min.	Тур.	Max.	Unit	Note
Supply voltage	V_{DD}	3.0	3.3	3.6	V	
	ViH	$0.7 V_{DD}$	_	V _{DD}	V	Note (1)
Input signal voltage	ViL	GND	_	$0.3 V_{DD}$	V	Note (1)
Current of power supply	lod	_	TBD	—	mA	$V_{DD} = 3.3V$

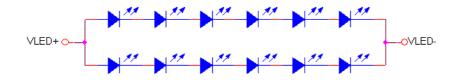
Note (1): HSYNC, VSYNC, DE, R/G/B Data

Note (2): GND = 0V

6.2 Back-Light Unit

The backlight system is an edge-lighting type with 12 LED. The characteristics of the LED are shown in the following tables.

Parameters	Symbol	Min.	Тур.	Max.	Unit	Note
LED current	IL		40		mA	(2)
LED voltage	VL		19.8		V	
LED life time	Hr	10000			Hour	(1)(2)

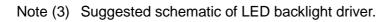


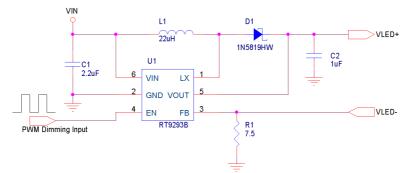
LED Light Bar Circuit

- Note (1) LED life time (Hr) can be defined as the time in which it continues to operate under the condition: Ta= 25 ± 3 °C, typical IL value indicated in the above table until the brightness becomes less than 50%.
- Note (2) The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta= 25° C and IL=40mA. The LED lifetime could be decreased if operating IL is larger than 40mA. The constant current driving method is suggested.

	Diamlass	0
HannStar	Display	Corp.

HannStar	HannStar Display Corp.		
Document Title	HSD043I9W1 Specification	Page No.	13/22
Document No.	DC170-002854	Revision	1.0



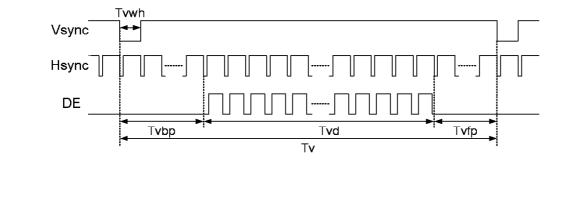


6.3 Data Input Format

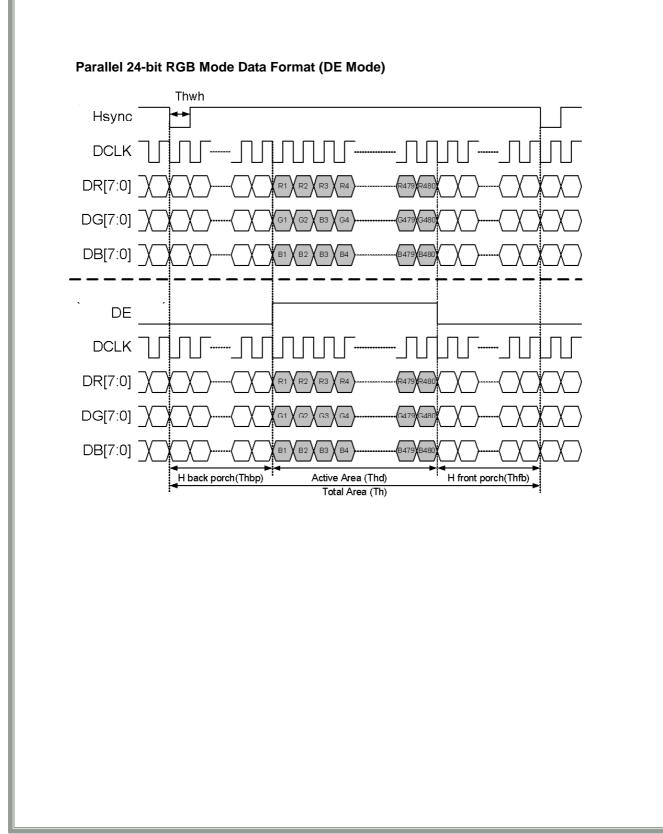
Parallel 24-bit RGB Input Timing Table

Parameters	Symbol	Min.	Тур.	Max.	Unit	Conditions
DCLK frequency	fclk	5	9	12	MHz	
VSYNC period time	Τv	277	288	400	Th	
VSYNC display area	Tvd		272		Th	
VSYNC back porch	Tvbp	3	8	31	Th	
VSYNC front porch	Tvfp	2	8	93	Th	
HSYNC period time	Th	520	525	800	DCLK	
HSYNC display area	Thd		480		DCLK	
HSYNC back porch	Thbp	36	40	255	DCLK	
HSYNC front porch	Thfp	4	5	65	DCLK	





HannStar	HannStar Display Corp.		
Document Title	HSD043I9W1 Specification	Page No.	14/22
Document No.	DC170-002854	Revision	1.0



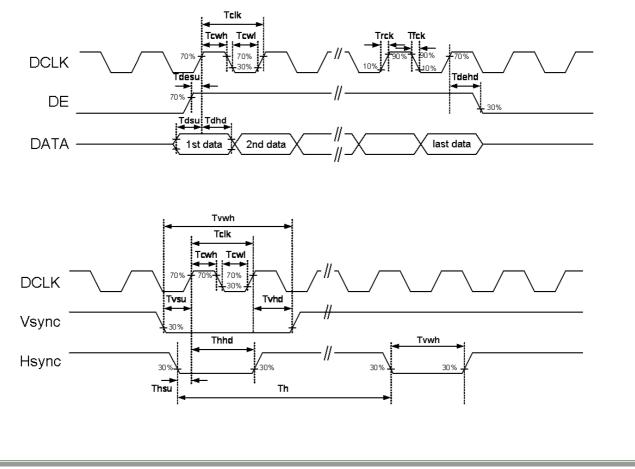


Document Title	HSD043I9W1 Specification	Page No.	15/22
Document No.	DC170-002854	Revision	1.0

6.4 AC Electrical Characteristics

Parameters	Symbol	Min.	Тур.	Max.	Unit	Conditions
DCLK period time	Tclk	83.3	111.1	200	ns	Parallel 24-bit RGB mode
DCLK period time	TCIK	33.3	37.0	41.7	ns	Serial 8-bit RGB mode
DCLK rising time	Trck	-	-	9	ns	
DCLK falling time	Tfck	-	-	9	ns	
DCLK pulse duty	Tcwh	40	50	60	%	
DE setup time	Tdesu	12	-	-	ns	
DE hold time	Tdehd	12	-	-	ns	
HSYNC pulse width	Thwh	1	-	-	DCLK	
HSYNC setup time	Thsu	12	-	-	ns	
HSYNC hold time	Thhd	12	-	-	ns	
VSYNC pulse width	Tvwh	1	-	-	Th	
VSYNC setup time	Tvsu	12	-	-	ns	
VSYNC hold time	Tvhd	12	-	-	ns	
Data setup time	Tdsu	12	-	-	ns	
Data hold time	Tdhd	12	-	-	ns	

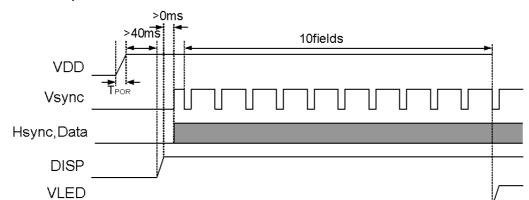
Clock and Data Input Timing Diagram



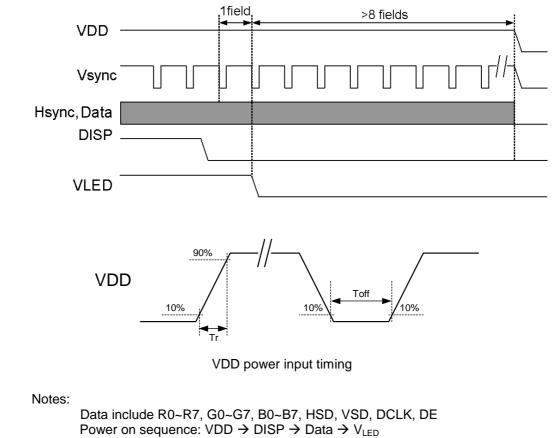


Document Title	HSD043I9W1 Specification	Page No.	16/22
Document No.	DC170-002854	Revision	1.0

6.5 Power On/Off Sequence Power On Sequence



Power Off Sequence

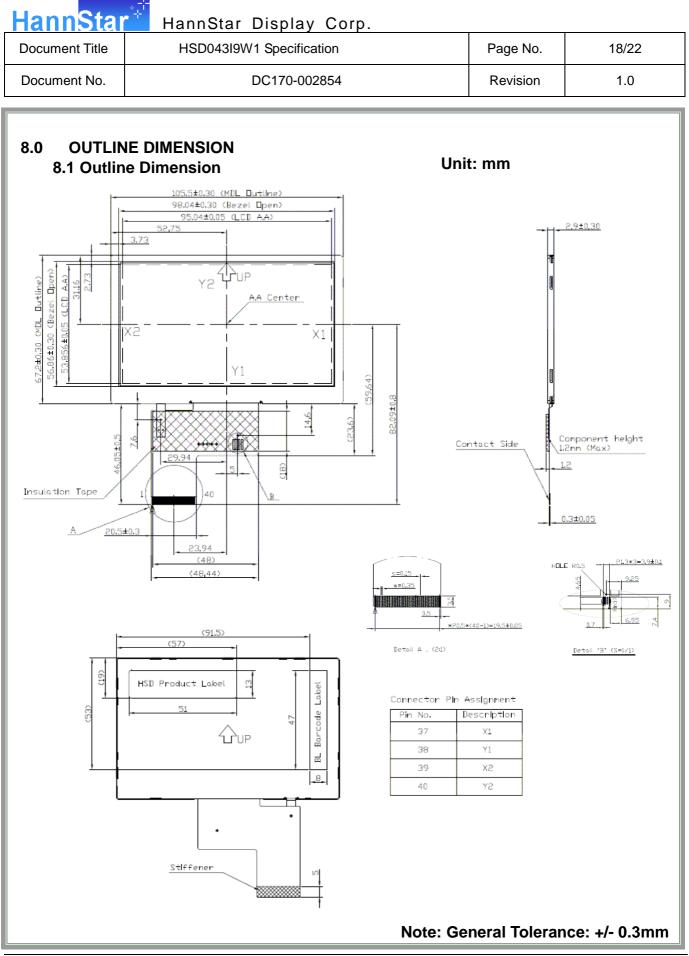


Power on sequence: $VDD \rightarrow DISP \rightarrow Data \rightarrow V_{LED}$ Power off sequence: $DISP \rightarrow V_{LED} \rightarrow Data \rightarrow VDD$ VDD power input timing: 0.5ms < Tr < 10ms; Toff > 500ms

Document Title	HSD043I9W1 Specification	Page No.	17/22
Document No.	DC170-002854	Revision	1.0

7.0 Reliability test items No. Item Conditions Remark Ta=+80°C, 240hrs 1 High Temperature Storage 2 Low Temperature Storage Ta=-30°C, 240hrs Ta=+70°C, 240hrs 3 High Temperature Operation 4 Low Temperature Operation Ta=-20°C, 240hrs 5 High Temperature and High Humidity Ta=+60°C, 90%RH, 240hrs (operation) 6 Thermal Cycling Test (non operation) $-30^{\circ}C(30min) \rightarrow +80^{\circ}C(30min)$, 200cycles 7 Electrostatic Discharge $\pm 200V, 200pF(0\Omega)$ 1 time/each terminal 8 Vibration 1.Random: 1.04Grms, 5~500Hz, X/Y/Z, 30min/each direction 2. Sine: Freq. Range: 8~33.3Hz Stoke: 1.3mm Sweep: 2.9G, 33.3~400Hz X/Z: 2hr, Y: 4hr, cyc: 15min 9 Shock 100G, 6ms, ±X, ±Y, ±Z JIS C7021, A-10 3 time for each direction (Condition A) 10 Vibration (with carton) Random: 0.015G^2/Hz, 5~200Hz -6dB/Octave, 200~400Hz XYZ each direction: 2hr 11 Drop (with carton) Height: 60cm **JIS Z0202** 1 corner, 3 edges, 6 surfaces

Note: There is no display function NG issue occurred, all the cosmetic specification is judged before the reliability stress.



The information contained in this document is the exclusive property of HannStar Display Corporation. It shall not be disclosed, distributed or reproduced in whole or in part without written permission of HannStar Display Corporation.



Document Title	HSD043I9W1 Specification	Page No.	19/22
Document No.	DC170-002854	Revision	1.0

9.0 LOT MARK

9.1 Lot Mark



code 1,2,3,4,5,6: HannStar internal flow control code.

code 7: production location.

code 8: production year.

code 9: production month.

code 10,11,12,13,14,15: serial number.

Note (1) Production Year: Code 8 is defined by the last number of the year, for example

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010
Mark	1	2	3	4	5	6	7	8	9	0

Note (2) Production Month

Month	Jan.	Feb.	Mar.	Apr.	May.	Jun.	Jul.	Aug.	Sep.	Oct	Nov.	Dec.
Mark	1	2	3	4	5	6	7	8	9	А	В	С

9.2 Location of Lot Mark

- (1) Location: The label is attached to the backside of the LCD module. See Section 8.0 OUTLINE DIMENSION).
- (2) Detail of the Mark: as attached below.

(3) This is subject to change without prior notice.





Document Title	HSD043I9W1 Specification	Page No.	20/22
Document No.	DC170-002854	Revision	1.0

10.0 PACKAGE SPECIFICATION 10.1 Packing form LCM Model LCM Qty. in the box Inner Box Size (mm) Notice HSD043I9W1-A 210 408 x 369 x 180 10.2 Packing assembly drawings ESD Bag LCM 1. 3. Fold Back Corner Pad Partition/Pad Таре LCM+ESD bag Таре 4 MELENBERN Ø 5. Вох 6.

Items	Material	Notice
Box	Corrugated Paperboard	
Partition/Pad	Corrugated Paperboard	
Corner Pad	Corrugated Paperboard	
ESD bag	Corrugated Paperboard	



Document Title	HSD043I9W1 Specification	Page No.	21/22
Document No.	DC170-002854	Revision	1.0

11.0 GENERAL PRECAUTION

11.1 Use Restriction

This product is not authorized for use in life supporting systems, aircraft navigation control systems, military systems and any other application where performance failure could be life-threatening or otherwise catastrophic.

11.2 Disassembling or Modification

Do not disassemble or modify the module. It may damage sensitive parts inside LCD module, and may cause scratches or dust on the display. HannStar does not warrant the module, if customers disassemble or modify the module.

11.3 Breakage of LCD Panel

- 11.3.1.If LCD panel is broken and liquid crystal spills out, do not ingest or inhale liquid crystal, and do not contact liquid crystal with skin.
- 11.3.2. If liquid crystal contacts mouth or eyes, rinse out with water immediately.
- 11.3.3. If liquid crystal contacts skin or cloths, wash it off immediately with alcohol and rinse thoroughly with water.
- 11.3.4. Handle carefully with chips of glass that may cause injury, when the glass is broken.

11.4 Electric Shock

- 11.4.1. Disconnect power supply before handling LCD module.
- 11.4.2. Do not pull or fold the LED cable.
- 11.4.3. Do not touch the parts inside LCD modules and the fluorescent LED's connector or cables in order to prevent electric shock.

11.5 Absolute Maximum Ratings and Power Protection Circuit

- 11.5.1. Do not exceed the absolute maximum rating values, such as the supply voltage variation, input voltage variation, variation in parts' parameters, environmental temperature, etc., otherwise LCD module may be damaged.
- 11.5.2. Please do not leave LCD module in the environment of high humidity and high temperature for a long time.
- 11.5.3. It's recommended to employ protection circuit for power supply.



Document Title	HSD043I9W1 Specification	Page No.	22/22
Document No.	DC170-002854	Revision	1.0

11.6 Operation

- 11.6.1 Do not touch, push or rub the polarizer with anything harder than HB pencil lead.
- 11.6.2 Use fingerstalls of soft gloves in order to keep clean display quality, when persons handle the LCD module for incoming inspection or assembly.
- 11.6.3 When the surface is dusty, please wipe gently with absorbent cotton or other soft material.
- 11.6.4 Wipe off saliva or water drops as soon as possible. If saliva or water drops contact with polarizer for a long time, they may causes deformation or color fading.
- 11.6.5 When cleaning the adhesives, please use absorbent cotton wetted with a little petroleum benzine or other adequate solvent.

11.7 Mechanism

Please mount LCD module by using mounting holes arranged in four corners tightly.

11.8 Static Electricity

- 11.8.1 Protection film must remove very slowly from the surface of LCD module to prevent from electrostatic occurrence.
- 11.8.2. Because LCD module use CMOS-IC on circuit board and TFT-LCD panel, it is very weak to electrostatic discharge. Please be careful with electrostatic discharge. Persons who handle the module should be grounded through adequate methods.

11.9 Strong Light Exposure

The module shall not be exposed under strong light such as direct sunlight. Otherwise, display characteristics may be changed.

11.10 Disposal

When disposing LCD module, obey the local environmental regulations.